

PN3566

NPN General Purpose Amplifier

- This device is for use as a medium amplifier and switch requiring collector currents up 300mA.
- Sourced from process 19.



1. Emitter 2. Base 3. Collector

Absolute Maximum Ratings T_a =25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------------------------|--|------------|-------|
| V _{CEO} | Collector-Emitter Voltage | 30 | V |
| V _{CBO} | Collector-Base Voltage | 40 | V |
| V _{EBO} | Emitter-Base Voltage | 5 | V |
| I _C | Collector Current - Continuous | 600 | mA |
| T _{J,} T _{STG} | Operating and Storage Junction Temperature Range | - 55 ~ 150 | °C |

Electrical Characteristics T_a =25°C unless otherwise noted

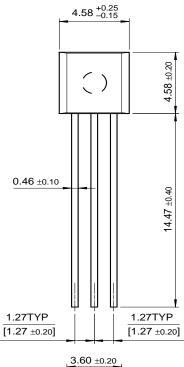
| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Units |
|--|--|---|------|------|------|-------|
| Off Chara | Off Characteristics | | | | | |
| V _{(BR)CEO} | Collector-Emitter Breakdown Voltage * | $I_C = 30 \text{mA}, I_B = 0$ | 30 | | | V |
| V _{(BR)CBO} | Collector-Base Breakdown Voltage | $I_C = 100 \mu A, I_E = 0$ | 40 | | | V |
| V _{(BR)EBO} | Emitter-Base Breakdown Voltage | $I_E = 10\mu A, I_C = 0$ | 5 | | | V |
| I _{CBO} | Collector Cut-off Current | $V_{CB} = 20V, I_{E} = 0$ | | | 50 | nA |
| I _{EBO} | Emitter Cut-off Current | $V_{EB} = 5V, I_{C} = 0$ | | | 10 | μΑ |
| On Characteristics | | | | | | |
| h _{FE} | DC Current Gain | $V_{CE} = 10V, I_{C} = 2.0mA$ | 80 | | | |
| | | $V_{CE} = 10V, I_{C} = 10mA$ | 150 | | 600 | |
| V _{CE} (sat) | Collector-Emitter Saturation Voltage * | I _C = 100mA, I _B = 10mA | | | 1.0 | V |
| V _{BE} (on) | Base-Emitter On Voltage | $V_{CE} = 1V, I_{C} = 100mA$ | | | 0.9 | V |
| Small Signal Characteristics | | | | | | |
| C _{obo} | Output Capacitance | $V_{CB} = 10V, I_{E} = 0$ | | | 25 | pF |
| Pulse Test: Pulse Width < 300ms. Duty Cycle < 2.0% | | | | | | |

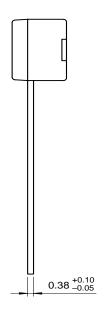
Thermal Characteristics T_a =25°C unless otherwise noted

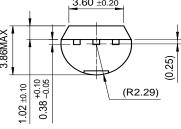
| Symbol | Parameter | Max. | Units |
|-----------------|---|------|-------|
| P _D | Total Device Dissipation | 625 | mW |
| | Derate above 25°C | 5 | mW/°C |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 83.3 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 200 | °C/W |

Package Dimensions

TO-92







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|--------------------------|---------------------------|---|
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